

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3400 uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

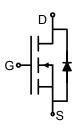
• $V_{DS} = 30V, I_D = 5.8A$

 $R_{DS(ON)}$ < 57m Ω @ V_{GS} =2.5V

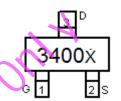
 $R_{DS(ON)}$ < 41m Ω @ V_{GS} =4.5V

 $R_{DS(ON)}$ < 35m Ω @ V_{GS} =10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

Device Marking	Device	D	evice Package	Reel Size	Tape width	Quantity
3400 X	NCE3400		SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±12	V
Drain Current-Continuous	I _D	5.8	Α
Drain Current-Pulsed (Note 1)	I _{DM}	30	Α
Maximum Power Dissipation	P _D	1.4	W
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}\!$

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	89	°C/W
, and the second		1	1

Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μΑ

I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA
$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	0.7	0.9	1.2	V
	V _{GS} =2.5V, I _D =4A	-	28	57	mΩ
R _{DS(ON)}	V _{GS} =4.5V, I _D =5A	-	24	41	mΩ
V _{GS} =10V, I _D =5A	-	22	35	mΩ	
g FS	V _{DS} =5V,I _D =5A	10	-	-	S
C _{lss}	\/ -15\/\/ -0\/	-	820	-	PF
Coss		-	99	-	PF
C _{rss}	F=1.0WHZ	1	77	-	PF
t _{d(on)}		-	3.3	-	nS
t _r	V_{DD} =15V, R_L =2.7 Ω	-	4.8	-	nS
$t_{\sf d(off)}$	V_{GS} =10 V_{RGEN} =3 Ω	-	26	-	nS
t _f	115	-	4	-	nS
Qg	\\ -15\\\\ -5A	-	9.5	-	nC
Q_{gs}		-	1.5	-	nC
Q_{gd}	VGS-4.5V	-	3	-	nC
V _{SD}	V _{GS} =0V,I _S =5A	-	-	1.2	>
I _S		-	-	5.8	Α
	$V_{GS(th)}$ $R_{DS(ON)}$ g_{FS} C_{Iss} C_{oss} C_{rss} $t_{d(on)}$ t_r $t_{d(off)}$ t_f Q_g Q_{gs} Q_{gd} V_{SD}	$\begin{array}{ c c c c } \hline V_{GS(th)} & V_{DS} = V_{GS}, I_D = 250 \mu A \\ \hline V_{GS} = 2.5 V, \ I_D = 4 A \\ \hline V_{GS} = 4.5 V, \ I_D = 5 A \\ \hline V_{GS} = 10 V, \ I_D = 5 A \\ \hline V_{DS} = 5 V, I_D = 5 A \\ \hline \hline C_{ISS} & V_{DS} = 5 V, V_{GS} = 0 V, \\ \hline C_{COSS} & F = 1.0 MHz \\ \hline \hline t_{r} & V_{DD} = 15 V, R_L = 2.7 \Omega \\ \hline t_{d(off)} & V_{GS} = 10 V, R_{GEN} = 3 \Omega \\ \hline t_{f} & Q_g & V_{DS} = 15 V, I_D = 5 A, \\ \hline Q_{gS} & V_{DS} = 4.5 V \\ \hline \hline V_{SD} & V_{GS} = 0 V, I_S = 5 A \\ \hline I_{S} & V_{GS} = 0 V, I_S = 5 A \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{ c c c c c c } \hline V_{GS(th)} & V_{DS}=V_{GS}, I_D=250 \mu A & 0.7 & 0.9 \\ \hline V_{GS}=2.5 V, I_D=4 A & - & 28 \\ \hline V_{GS}=4.5 V, I_D=5 A & - & 24 \\ \hline V_{GS}=10 V, I_D=5 A & - & 22 \\ \hline Q_{FS} & V_{DS}=5 V, I_D=5 A & 10 & - \\ \hline \hline C_{ISS} & V_{DS}=5 V, V_{GS}=0 V, & - & 99 \\ \hline C_{rss} & F=1.0 MHz & - & 4.8 \\ \hline t_{d(on)} & V_{GS}=15 V, V_{GS}=0 V, & - & 4.8 \\ \hline t_{d(off)} & V_{GS}=10 V, R_{GEN}=3 \Omega & - & 26 \\ \hline t_{f} & - & 4 \\ \hline Q_{g} & V_{DS}=15 V, I_D=5 A, & - & 9.5 \\ \hline Q_{gd} & V_{GS}=4.5 V & - & 3 \\ \hline \end{array}$	$\begin{array}{ c c c c c c } \hline V_{GS(th)} & V_{DS}{=}V_{GS},I_{D}{=}250\mu A & 0.7 & 0.9 & 1.2 \\ \hline V_{GS}{=}2.5V,\ I_{D}{=}4A & - & 28 & 57 \\ \hline V_{GS}{=}4.5V,\ I_{D}{=}5A & - & 24 & 41 \\ \hline V_{GS}{=}10V,\ I_{D}{=}5A & - & 22 & 35 \\ \hline g_{FS} & V_{DS}{=}5V,I_{D}{=}5A & 10 & - & - \\ \hline \hline C_{ISS} & V_{DS}{=}5V,V_{GS}{=}0V, \\ \hline C_{CSS} & F{=}1.0MHz & - & 820 & - \\ \hline C_{TSS} & - & 99 & - & - \\ \hline t_{I} & V_{DD}{=}15V,\ R_{L}{=}2.7\Omega & - & 4.8 & - \\ \hline t_{I} & V_{DS}{=}15V,I_{D}{=}5A, \\ \hline V_{GS}{=}4.5V & - & 9.5 & - \\ \hline Q_{g} & V_{DS}{=}15V,I_{D}{=}5A, \\ \hline V_{GS}{=}4.5V & - & 3 & - \\ \hline V_{SD} & V_{GS}{=}0V,I_{S}{=}5A & - & - & 1.2 \\ \hline I_{S} & - & - & 5.8 \\ \hline \end{array}$

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

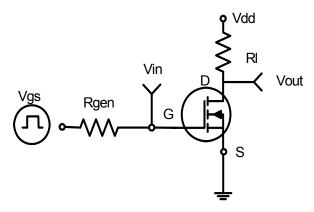


Figure 1:Switching Test Circuit

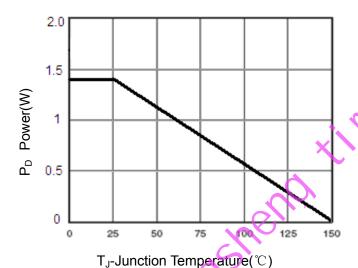


Figure 3 Power Dissipation

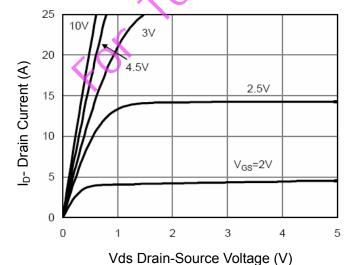


Figure 5 Output Characteristics

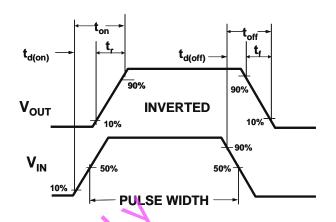


Figure 2:Switching Waveforms

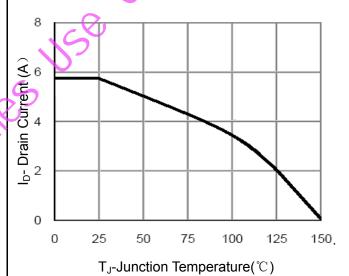
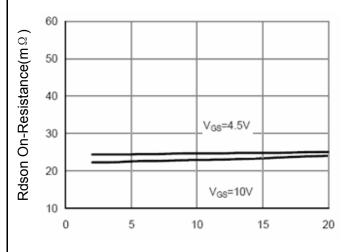


Figure 4 Drain Current



I_D- Drain Current (A) Figure 6 Drain-Source On-Resistance



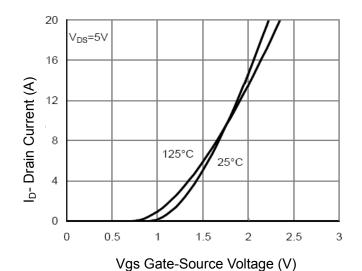
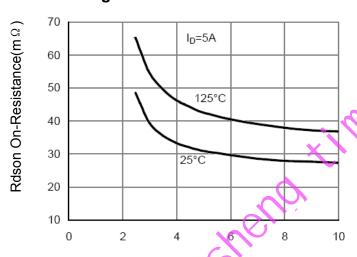
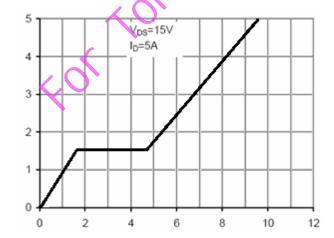


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)
Figure 9 Rdson vs Vgs



Vgs Gate-Source Voltage (V)

Figure 11 Gate Charge

Qg Gate Charge (nC)

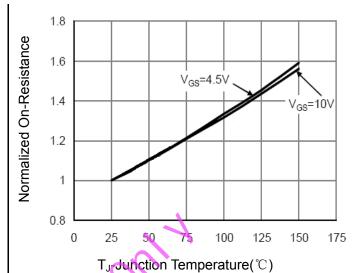


Figure 8 Drain-Source On-Resistance

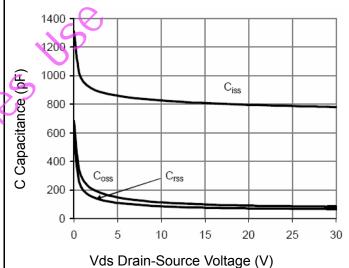


Figure 10 Capacitance vs Vds

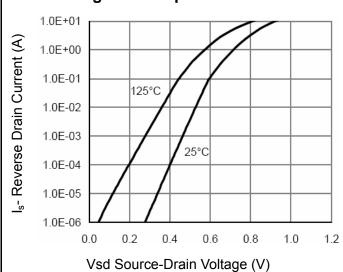


Figure 12 Source- Drain Diode Forward



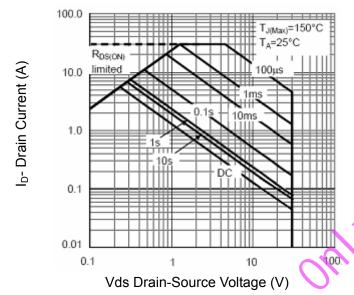


Figure 13 Safe Operation Area

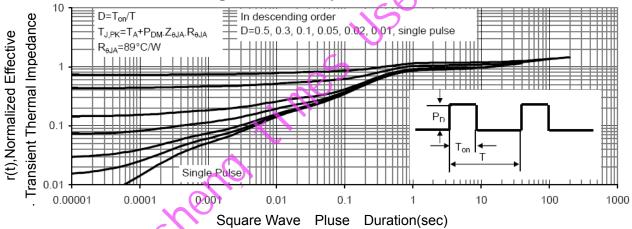
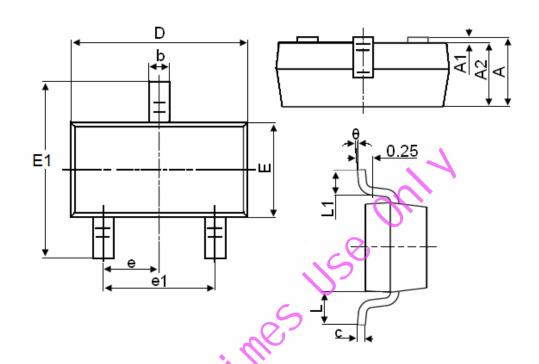


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
А	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
С	0.080	0.150			
D	2.800	3.000			
E	1.200	1.400			
E	2.250	2.550			
е	0.950TYP				
e1	1.800	2.000			
L	0.550REF				
L1	0.300	0.500			
θ	0°	8°			

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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